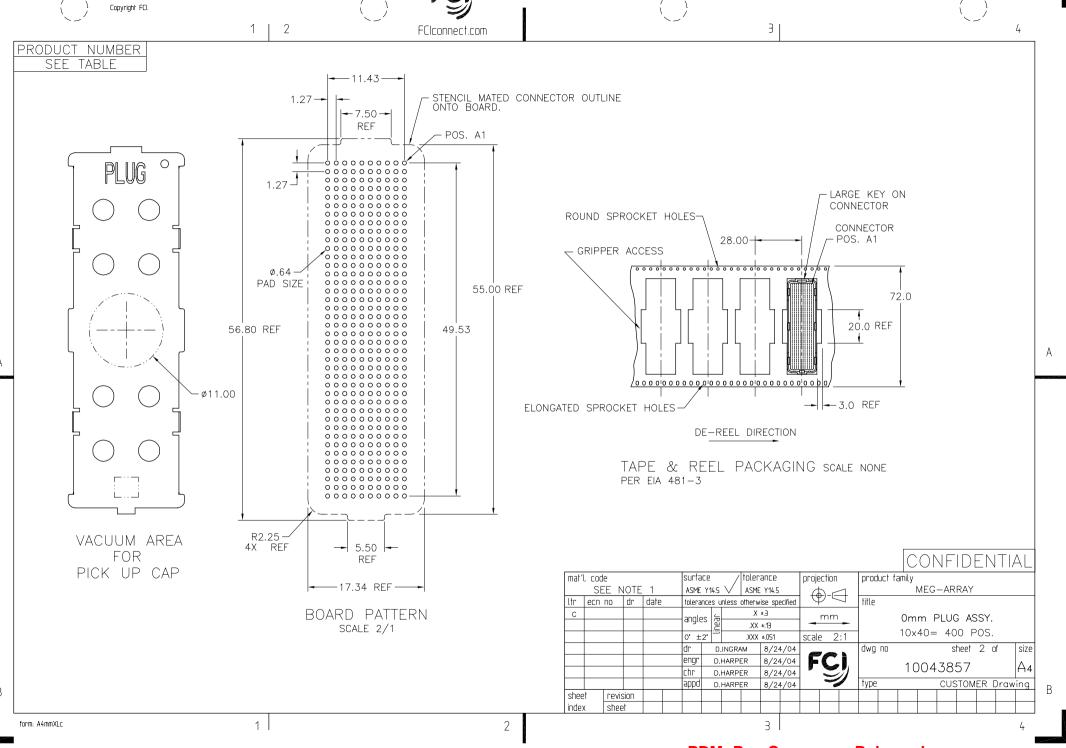


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PDM: Rev:C STATUS Released Printed: Oct 21, 2010



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PRODUCT NUMBER	PICK-UP CAP	CONTACT PLATING	SOLDER BALL
10043857-102	VEC	70.7/0.70	SnPb
10043857-102LF	YES	30u"(0.76um) Au OVER Ni	SnAgCu LEAD FREE 67
10043857-202	VEC	055 14455 1451014 74515 (551 041)	SnPb
10043857-202LF	YES	SEE MATED HEIGHT TABLE (BELOW)	SnAgCu LEAD FREE (6)(7)

NOTES:

MAT'L:

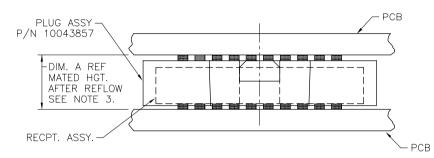
HOUSING: LCP

CONTACT: COPPER ALLOY

PLATING:

CONTACT: (SEE TABLE ON SHEET3) SOLDER BALL: (SEE TABLE ON SHEET3) EUTECTIC SnPb OR LEAD FREE 95.5Sn/4Aa/0.5Cu

- (2.) SOLDER BALLS WILL NOT BE PERFECT SPHERICAL SHAPE DUE TO REFLOW ATTACHMENT.
- (3.) MATED HEIGHT EFFECTED BY CUSTOMER'S PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE, & SOLDER PASTE.
- (4.) PLATING FOR INDICATED -2XX SERIES PART NOS. MEETS THE REQUIREMENTS OF NORTEL NPS25298-2 (CENTRAL OFFICE ENVIRONMENT, 25 YEAR LIFE EXPECTANCY).
- (5.) PLATING FOR INDICATED -2XX SERIES PART NOS. IS AU OVER NI WITH SPECIAL CONTACT GEOMETRY TO MEET REQUIREMENTS OF TELCORDIA GR-1217-CORE: CENTRAL OFFICE ENVIRONMENT.
- (6.) FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEAD FREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE. LEAD FREE PRODUCT IS THERFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION
- (7.) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008 PRODUCT MEETING THIS DIRECTIVE IS IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION



MATED HEIGHT TABLE										
DIM. A	-2XX PLATING									
4.0	74221	SEE NOTE 4								
6.0	74388	SEE NOTE 5								
8.0	74390	SEE NOTE 5								

MATED HEIGHT AFTER REFLOW IS BASED ON Ø .64mm PAD (METAL-DEFINED) AND .13mm SOLDER PASTE STENCIL THICKNESS, SEE NOTE 3.

END VIEW - MATED CONNECTORS SCALE NONE

CONFIDENTIAL	
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mat'l. code				surface / tolerance					projection			product family									
	SEE NOTE 1				ASME Y14.5 ASME Y14.5				\$ 7		MEG-ARRAY										
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С	С			angle	s a	E.± X.			mm			0mm PLUG ASSY.									
				dilgit	<u>. </u>		INGRAM 8 HARPER 8 HARPER 8		(X ±.13 (X ±.051		-				10×40= 400 POS.						
				0° ±:	2						e 2	:1			10840=)U F	05.		
				dr	D	.INGR/			4/04				dwg	םח			S	heet	3 (of	size
				engr	D.	HARP			8/24/04		C				1 ($\cap A$	70	57			A4
				chr	D.	HARP			8/24/04 8/24/04		' <i>\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\</i>				10043			3637			<u> </u>
				appd	D.	HARP							type				CUS	MOT	IER I	Draw	ing
shee	t revi	sion																			
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STATUSReleased

Printed: Oct 21, 2010

form: A4mmXLc

PDM: Rev:C

Mouser Electronics

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10043857-202 10043857-202LF